## IN THE UNITED STATES ATENT AND TRADEMARK OFFICE

In re application of:

Nagesh Vodrahalli

Application No.: 09/475,104

Filed: December 30, 1999

For: High Performance Thermal Interface

Curing Process for Organic Flip Chip

Packages

Group No.: 2811

Examiner: Unassigned

RECEIVED

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**OFFICE OF PETITIONS** 

Box DAC Assistant Commissioner for Patents Washington, DC 20231

Attention: Petition Information

Crystal Park One, Suite 520

## PETITION FOR REVIVAL OF AN APPLICATION FOR PATENT ABANDONED UNINTENTIONALLY UNDER 37 C.F.R. § 1.137(b)

## Dear Sir or Madam:

This application became abandoned on August 9, 2000.

This application became abandoned due to a docketing error that was recently uncovered by the undersigned attorney. To date, we have not yet received a Notice of Abandonment from the United States Patent and Trademark Office. The entire delay in filing the required reply from the due date until the file of this petition was unintentional 37 C.F.R. § 1.137(b)(3).

The expected Response to Missing Parts is attached herewith.

042390.P6785 App. No. 09/475,104 -1-

WWS/v Filed 12/30/20

02 FC:105

12/08/2000 SLUANGI 00000092 09475104

Applicant submits herewith a petition fee of \$1,240.00. Please charge any additional fees or credit any overpayment to Deposit Account 02-2666. A duplicate copy of the Fee Transmittal is enclosed for this.

Respectfully submitted,

Blakely, Sokoloff, Taylor & Zafman LLP

Date: December 5, 2000

William W. Schaal, Reg. No. 39,018

12400 Wilshire Boulevard, Seventh Floor Los Angeles, California 90025 (714) 557-3800 CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:
Assistant Commissioner for Patents, Washington, D.C. 20231 on: December 5, 2000.

12/05/00

Date